

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the present application.

Listing of Claims:

Claim 1 (currently amended): A wafer holder for semiconductor manufacturing equipment, the wafer holder having a wafer-carrying surface ~~and being trapezoidal in cross-section,~~ such that the diameter *a* of the wafer holder wafer-carrying surface is not greater than the diameter *b* of the wafer holder surface on its side opposite the wafer-carrying surface, wherein the diameter *b* minus the diameter *a* is less than ~~35 mm~~ 1 mm, and wherein the wafer holder is dimensioned to increase in diameter continuously from diameter *a* to diameter *b*.

Claim 2 (canceled)

Claim 3 (original): The wafer holder set forth in claim 1, being a ceramic susceptor interiorly in or superficially on which a resistive heating element is formed.

Claim 4 (canceled)

Claim 5 (original): Semiconductor manufacturing equipment wherein the wafer holder set forth in claim 1 is installed.

Claim 6 (canceled)

Claim 7 (original): Semiconductor manufacturing equipment wherein the wafer holder set forth in claim 3 is installed.

Claims 8-13 (canceled)